

N-Channel Field Effect Transistor

Description

The Bay Linear n-channel power field effect transistors are produced using high cell density DMOS technology , These devices are particularly suited for high voltage applications such as automotive and other battery powered circuits where fast switching, low in-line power loss and resistance to transistors are needed.

The TO-220 is offered in a 3-pin is universally preferred for all commercial-industrial applications at power dissipation level to approximately to 50 watts. Also, available in a D^2 surface mount power package with a power dissipation up to 2 Watts



Features

- Critical DC Electrical parameters specified at elevated Temp.
- Rugged internal source-drain diode can eliminate the need for external Zener diode transient suppresser
- Super high density cell design for extremely low R_{DS(ON)}

$$\begin{split} V_{DSS} &= 600V \\ R_{DS\,(ON)} &= 1.9~\Omega \\ I_D &= 4.0A \end{split}$$

Ordering Information

Device	Package	Temp.
4N600T	TO-220	0 to 150°C
4N600S	$TO-263 (D^2)$	0 to 150°C

Absolute Maximum Rating

Symbol	Parameter	Max	Unit	
$I_{D} (T_{C}=25^{\circ}C)$	Drain Current	4.0	A	
$I_{D} (T_{C}=25^{\circ}C)$ $I_{D} (T_{C}=100^{\circ}C)$	-Continues	2.5		
_ ,	-Pulsed	16		
V_{GSV}	Gate Source Voltage	±20	V	
P _D	Total Power Dissipation @ T _C =25°C	75	W	
	Derate above 25°C	0.59	W/°C	
$T_{ m J}$	Operating and Storage	-55 to 150	°C	
T_{STG}	Temperature Range		-C	

Electrical Characteristics ($T_C = 25$ °C unless otherwise specified)

Symbol	Parameter	Conditions	Min	Тур	Max	Units	
I_{DSS}	Zero Gate Voltage Drain Curren	$\left \begin{array}{c} V_{DS} = 600V \\ V_{GS} = 0V \end{array} \right $			100	μА	
V	Drain-to-Source Breakdown	$I_D=100\mu A, V_{GS}=0$	600	-	-	V	
V _{GS(TH)}	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=250\mu A$	2		4	V	
$R_{DS(ON)}$	Static Drain Voltage	$V_{GS}=10V, I_{D}=2.4A$	-	-	1.9	Ω	
I_{GSS}	Gate-to-Source Forward Leakag	e V _{GS} =20V			100	NA	
	Gate-to-Source Reverse Leakage	$V_{GS}=-20V$			-100		
\mathbf{g}_{fs}	Forward Tranconductance	$V_{DS}=100V, I_{D}=2.4A$	2.9			S	
C _{ISS}	Input Capacitance	V _{DS} = 25V, V _{GS} =0V F=1.0 MHZ		800		pF	
C_{OSS}	Output Capacitance			110		pF	
C_{RSS}	Reverse Tras. Capacitance			20		pF	
$t_{D(ON)}$	Turn-ON Delay Time	$\begin{array}{c} & V_{DD} = 300V \\ I_{D} = 2.4A, R_{GEN} = 12\Omega \\ R_{D} = 74\Omega \end{array}$		12		- NS	
$\mathbf{t_r}$	Turn-ON Rise Time			18			
$t_{d(off)}$	Turn-OFF Delay Time			53			
t_{F}	Turn-OFF Fall Time			19			
I_S	Maxim Continuous Drain source Diode Forward Current				4.0	A	
V _{DS} (note)	Drain Source Diode	V _{GS} =0V			1.50	V	
	Forward Voltage	$I_S=4A$			1.50	V	
THERMAI	CHRACTERISTICS			<u>.</u>			
$\mathbf{R}_{\mathbf{JC}}$	Thermal Resistance, Junction to Case				5	°C/W	
$\mathbf{R}_{\mathbf{JC}}$	Thermal Resistance, Junction to Ambient				100	°C/W	

Note: Pulse Test: Pulse With $\leq 300 \mu S$, Duty Cycle $\leq 2.0\%$

Advance Information- These data sheets contain descriptions of products that are in development. The specifications are based on the engineering calculations, computer simulations and/ or initial prototype evaluation.

Preliminary Information- These data sheets contain minimum and maximum specifications that are based on the initial device characterizations. These limits are subject to change upon the completion of the full characterization over the specified temperature and supply voltage ranges.

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